

8-Bit Bidirectional Voltage-Level Translator with Auto Direction Sensing and ±15kV ESD Protection UM3308/UM3308H CSP20 2.4×1.9 UM3308UK TSSOP20 UM3308QA QFN20 4.5×3.5

General Description

UM3308/UM3308H/UM3308UK/UM3308QA is an 8-channel bidirectional voltage level translator with auto direction sensing and $\pm 15 \text{kV}$ ESD protection. This 8-channel non-inverting translator uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2V to 3.6V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65V to 5.5V. This allows for universal low-voltage bidirectional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, and 5V voltage nodes. Both I/O ports are auto-sensing; thus, no direction pin is required, making it ideal for data transfer between low-voltage ASICs/PLDs and higher voltage systems.

The UM3308/UM3308H/UM3308UK/UM3308QA operates at a guaranteed data rate of 20Mbps over the entire specified operating voltage range. Within specific voltage domains, higher data rates are up to 100Mbps.

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state. The UM3308/UM3308H is designed so that the OE input circuit is supplied by $V_{\rm CCA}$.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pull down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The UM3308 and UM3308H are both available in CSP20 2.4×1.9 bump package while the UM3308H specially features in wafer backside coating process, making the chip more unbreakable. The UM3308UK is available in TSSOP20 package and the UM3308QA is available in QFN20 4.5×3.5 package.

Applications

- Low-Voltage ASIC Level Translation
- Cell-Phone Cradles
- Portable POS Systems
- Portable Communication Devices
- Low-Cost Serial Interfaces
- Cell-Phones
- GPS
- Telecommunications Equipment

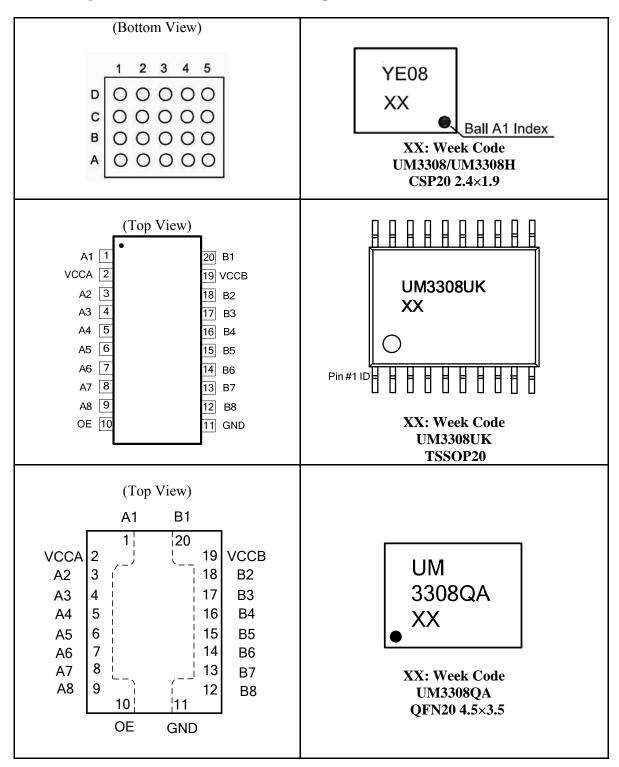
Features

- 1.2V to 3.6V on A Port and 1.65V to 5.5V on B Port ($V_{CCA} \le V_{CCB}$)
- V_{CC} Isolation Feature If Either V_{CC} Input is at GND, All Outputs are in the High-Impedance State
- OE Input Circuit Referenced to V_{CCA}
- Low Power Consumption
- Latch-Up Performance Exceeds 100mA
- ±15kV ESD Protection on B Ports



Pin Configurations

Top View





Ball Mapping for UM3308/UM3308H

	5	4	3 2		1
D	B8	B6	B4	B2	V _{CCB}
С	GND	B7	B5	B3	B1
В	OE	A7	A5	АЗ	A1
Α	A8	A6	A4	A2	V _{CCA}

Transparent Top View

Pin Description

Pin Name	Function
A1	Input/Output 1. Referenced to V _{CCA}
V_{CCA}	A-Port Supply Voltage. $1.1V \le V_{CCA} \le 3.6V$ and $V_{CCA} \le V_{CCB}$
A2	Input/Output 2. Referenced to V _{CCA}
A3	Input/Output 3. Referenced to V _{CCA}
A4	Input/Output 4. Referenced to V _{CCA}
A5	Input/Output 5. Referenced to V _{CCA}
A6	Input/Output 6. Referenced to V _{CCA}
A7	Input/Output 7. Referenced to V _{CCA}
A8	Input/Output 8. Referenced to V _{CCA}
OE	3-State Output Enable. Pull OE low to place all outputs in 3-state mode.
OE	Referenced to V _{CCA}
GND	Ground
В8	Input/Output 8. Referenced to V _{CCB}
B7	Input/Output 7. Referenced to V _{CCB}
В6	Input/Output 6. Referenced to V _{CCB}
B5	Input/Output 5. Referenced to V _{CCB}
B4	Input/Output 4. Referenced to V _{CCB}
В3	Input/Output 3. Referenced to V _{CCB}
B2	Input/Output 2. Referenced to V _{CCB}
V_{CCB}	B-Port Supply Voltage. 1.65V≤V _{CCB} ≤5.5V
B1	Input/Output 1. Referenced to V _{CCB}

Ordering Information

Part Number	Packaging Type	Marking Code	Shipping Qty
UM3308	CSP20 2.4×1.9	YE08	3000pcs/7Inch
UM3308H	CSF20 2.4^1.9	I EUO	Tape & Reel
UM3308UK	TSSOP20	UM3308UK	3000pcs/13Inch
OMSSOOK	1550120	OWISSOOCK	Tape & Reel
UM3308QA	QFN20 4.5×3.5	UM3308QA	3000pcs/13Inch
UM3308QA	Q11\20 4.5\3.3	0W3308QA	Tape & Reel



Absolute Maximum Ratings (Note 1)

Over operating free-air temperature range (unless otherwise noted)

Symbol	Parameter		Value	Unit	
V_{CCA}	Supply Voltage Range		-0.5 to +4.5	V	
V_{CCB}	Supply Voltage Range		-0.5 to +6.5	V	
V _I	Input Voltage Range (Note 2)	A ports B ports	-0.5 to +4.5 -0.5 to +6.5	V	
17	Voltage Range Applied to Any	A ports	-0.5 to +4.5	1 7	
V_{0}	Output in the High-Impedance or Power-Off State (Note 2)	B ports	-0.5 to +6.5	V	
1 7	Voltage Range Applied to Any	A ports	-0.5 to (V _{CCA} +0.5)	17	
V_{O}	Output in the High or Low State (Note 2, 3)	B ports	-0.5 to (V _{CCB} +0.5)	V	
I_{IK}	Input Clamp Current	$V_I < 0$	-50	mA	
I_{OK}	Output Clamp Current	$V_0 < 0$	-50	mA	
I_{O}	Continuous Output Current		±50	mA	
	Continuous Current through V _{CCA} , V ₀	_{CCB} , or GND	±100	mA	
$\theta_{ m JA}$	Package Thermal Impedance	78	°C/W		
T_{OP}	Operating Temperature Range		-40 to +85	°C	
T_{STG}	Storage Temperature Range		-65 to +150	°C	

- Note 1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- Note 2: The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- Note 3: The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

Recommended Operating Conditions (Note 1, 2)

Symbol	Parameter		V_{CCA}	V_{CCB}	Min	Max	Unit
V_{CCA}	Cumply V	altaga			1.2	3.6	V
V_{CCB}	Supply Vo	onage			1.65	5.5	V
V	High Level Input	Data Inputs	1.2V to 3.6V	1.65V to 5.5V	$V_{CCI} \times 0.65 (Note3)$	V _{CCI}	V
V_{IH}	Voltage	OE	1.2V to 3.6V	1.65V to 5.5V	$V_{CCA} \times 0.65$	5.5	V
V	Low Level Input	Data Inputs	1.2V to 5.5V	1.65V to 5.5V	0 V_{CC}	1×0.35	V
$V_{ m IL}$	Voltage	OE	1.2V to 3.6V	1.65V to 5.5V	$0 V_{CCA}$	×0.35	V
	Innut Tonnsition	A-Port Inputs	1.2V to 3.6V	1.65V to 5.5V		40	
$\Delta t/\Delta V$	Input Transition Rise or Fall Time B-Port Inputs 1.3		1.2V to 3.6V	1.65V to 3.6V		40	ns/V
	Kise of Fall Tille	B-Port Inputs	1.2 V 10 3.0 V	4.5V to 5.5V		30	

- Note 1: The A and B sides of an unused data I/O pair must be held in the same state, i.e., both at V_{CCI} or both at GND.
- Note 2: V_{CCA} must be less than or equal to V_{CCB} and must not exceed 3.6 V.
- Note 3: V_{CCI} is the supply voltage associated with the input port.



Electrical Characteristics (Note 1, 2)

Over recommended operating free-air temperature range (unless otherwise noted)

Danamatan	Took Conditions	T 7	3 7	$T_A = 1$	25°C	-40°C to	85°C	Unit	
Parameter	Test Conditions	V_{CCA}	V_{CCB}	Тур	Max	Min	Max	Unit	
$ m V_{OHA}$	I _{OH} =-20μA	1.2V		1.1				V	
V OHA	10H20μΑ	1.4V to 3.6V				V_{CCA} -0.4		v	
$ m V_{OLA}$	I _{OL} =20μA	1.2V		0.3				V	
	10L-20μΑ	1.4V to 3.6V					0.4	·	
V_{OHB}	I_{OH} =-20 μ A		1.65V to 5.5V			V_{CCB} -0.4		V	
V_{OLB}	$I_{OL}=20\mu A$		1.65V to 5.5V				0.4	V	
I _I OE		1.2V to 3.6V	1.65V to 5.5V		±1		±2	μΑ	
I _{off} A Port		0V	0V to 5.5V		±1		±2	μΑ	
B Port		0V to 3.6V	0V		±1		±2	μΛ	
I _{OZ} A or B Port	OE=GND	1.2V to 3.6V	1.65V to 5.5V		±1		±2	μΑ	
		1.2V	1.65V to 5.5V	0.06					
I_{CCA}	$V_I = V_{CCI}$ or GND	1.4V to 3.6V	1.65V to 5.5V				5	μΑ	
1CCA	$I_{O}=0$	3.6V	0V				2	μΑ	
		0V	5.5V				-2		
		1.2V	1.65V to 5.5V	3.5					
Ŧ	V _I =V _{CCI} or GND	1.4V to 3.6V	1.65V to 5.5V				5		
I_{CCB}	$I_{O}=0$	3.6V	0V				-2	μΑ	
		0V	5.5V				2		
$I_{CCA}+I_{CCB}$	V _I =V _{CCI} or GND	1.2V	1.65V to 5.5V	3.5				μA	
¹CCA ⁺ ¹CCB	$I_{O}=0$	1.4V to 3.6V	1.65V to 5.5V				10	μΑ	
ī	V _I =V _{CCI} or GND	1.2V	1.65V to 5.5V	0.05				4	
1 _{CCZA}	I_{CCZA} $I_{O}=0$, OE=GND		1.65V to 5.5V				5	μΑ	
ī	V _I =V _{CCI} or GND	1.2V	1.65V to 5.5V	3.5				۸	
I_{CCZB}	$I_{O}=0$, OE=GND		1.65V to 5.5V				5	μA	
C _i OE		1.2V to 3.6V	1.65V to 5.5V	5			5.5	pF	
C _{iO} A Port B Port		1.2V to 3.6V	1.65V to 5.5V	5 8			6.5	pF	

Note 1: V_{CCI} is the supply voltage associated with the input port.

Note 2: V_{CCO} is the supply voltage associated with the output port.



Switching Characteristics

 $T_A = +25$ °C, $V_{CCA} = 1.2V$

Parameter	From	To	$V_{CCB}=1.8V$	$V_{CCB}=2.5V$	$V_{CCB}=3.3V$	$V_{CCB}=5V$	Unit	
1 at afficter	(Input)	(Output)	Тур	Тур	Тур	Тур	Omt	
4	A	В	7	6	5.3	5.5	***	
$t_{\rm pd}$	В	A	7.5	6.5	6	6	ns	
4	OE	A	1	1	1	1		
t _{en}	OE	В	1	1	1	1	μs	
4	OE	A	18	8 16 1		14	ne	
$t_{ m dis}$	OE	В	19	17	15	15	ns	
$t_{rA,}t_{fA}$		se and Fall me	5	5	5	5	ns	
$t_{\mathrm{rB,}}t_{\mathrm{fB}}$	B Port Rise and Fall Time		2.5	1.5	1.2	1	ns	
$t_{SK(O)}$	Channel-t	o-Channel	0.5	0.5	0.5	1.5	ns	
Max Data Rate			20	20	20	20	Mbps	

Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =1.5V±0.1V (unless otherwise noted)

Parameter	From (Input)	To	V_{CCB} =1.8V ±0.15V		V_{CCB} =2.5V ±0.2V		V_{CCB} =3.3V ±0.3V		$V_{CCB}=5V$ $\pm 0.5V$		Unit
		(Output)	Min	Max	Min	Max	Min	Max	Min	Max	
4	A	В	2	15	1.2	11	1.1	10	1	10	10.0
$t_{ m pd}$	В	A	1	15	0.9	12	0.5	12	0.3	13	ns
t _{en} OE	A		1		1		1		1		
	В		1		1		1		1	μs	
4	OE	A	6	30	5.5	28	5.5	25	5.5	23	ne
$t_{ m dis}$	OL	В	5.5	30	5	25	5	20	5	20	ns
$t_{rA,} t_{fA}$	A Port Rise and Fall Time		1.5	5.0	1.5	5.0	1.5	5.0	1.5	5.0	ns
$t_{\rm rB,}t_{\rm fB}$	B Port Rise and Fall Time		0.9	4.5	0.6	3.5	0.5	3	0.4	2.5	ns
$t_{SK(O)}$	Channel-to-Channel			0.5		0.5		0.5		0.5	ns
Max Data Rate			40		40		40		40		Mbps



Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =1.8V±0.15V (unless otherwise noted)

Parameter	From	To (Output)	V _{CCB} =1.8V ±0.15V		V_{CCB} =2.5V ±0.2V		V _{CCB} =3.3V ±0.3V		V _{CCB} =5V ±0.5V		Unit
	(Input)	(Output)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	A	В	1.6	10	1.4	9	1.3	7	1.2	6.5	ng
	В	A	1.5	12	1.3	8.5	1	8	0.9	8	ns
4	, OF			1		1		1		1	
t _{en} OE	В		1		1		1		1	μs	
4	t _{dis} OE	A	6	34	5.5	23	5	20	5	17.6	ma
ι _{dis}		В	5.5	33	4.5	22	4.2	16.8	4.4	16.3	ns
$t_{rA,}t_{fA}$	A Port Rise and Fall Time		1	4.2	1.1	4.0	1.1	4.0	1.1	4.0	ns
$t_{\mathrm{rB},}t_{\mathrm{fB}}$	B Port Rise and Fall Time		0.9	4	0.6	3.2	0.5	2.8	0.4	2.8	ns
$t_{SK(O)}$	Channel-to-Channel			0.5		0.5		0.5		0.5	ns
Max Data Rate			60		60		60		60		Mbps

Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =2.5V±0.2V (unless otherwise noted)

Parameter	From	To (Output)	V_{CCB} =2.5V ±0.2V		V_{CCB} =3.3V ± 0.3 V		V _{CCB} =5V ±0.5V		Unit	
	(Input)	(Output)	Min	Max	Min	Max	Min	Max		
4	A	В	1.1	6.5	1	5.2	0.9	5	ma	
t_{pd}	В	A	1.2	6.6	1.1	5.1	0.9	4.4	ns	
4	OE	A		1		1		1		
t _{en}	OE	В		1		1		1	μs	
4	OE	A	5.0	23	4.6	15.2	4.6	13		
$t_{ m dis}$	OE	В	4.4	22	3.8	16	3.9	13.3	ns	
t_{rA} , t_{fA}	A Port Rise a	nd Fall Time	0.8	3	0.8	3	0.8	3	ns	
$t_{\rm rB,}t_{\rm fB}$	B Port Rise a	nd Fall Time	0.7	2.7	0.5	2.8	0.4	2.7	ns	
$t_{SK(O)}$	Channel-to		0.5		0.5		0.5	ns		
Max Data Rate			100		100		100		Mbps	



Switching Characteristics Over recommended operating free-air temperature range, V_{CCA} =3.3V±0.3V (unless otherwise noted)

Parameter	From	To (Output)		=3.3V .3V	V_{CCB} =5V ±0.5V		Unit
	(Input)	(Output)	Min	Max	Min	Max	
4	A	В	0.9	5	0.8	4	m G
t_{pd}	В	A	1	5.1	0.9	4	ns
4	OE	A		1		1	
$t_{\rm en}$	OE	В		1		1	μs
4	OE	A	5	15	4	13	
$t_{ m dis}$	OE	В	4	16	3.4	13.8	ns
t_{rA}, t_{fA}	A Port Rise a	nd Fall Time	0.7	2.5	0.7	2.5	ns
$t_{ m rB}$, $t_{ m fB}$	B Port Rise a	nd Fall Time	0.5	2.1	0.4	2.8	ns
$t_{SK(O)}$	Channel-to	Channel-to-Channel		0.5		0.5	ns
Max Data Rate			100		100		Mbps



Applications Information

UM3308/UM3308H/UM3308UK/UM3308QA ESD protected level translator provides level shifting necessary to allow data transfer in a multi-voltage system. Externally applied voltages, V_{CCA} and V_{CCB} set the logic levels on either side of device. A low voltage signal present on V_{CCA} side of the device appears as a high voltage logic signal on the V_{CCB} side of the device, and vice-versa.

Block Diagram

The UM3308/UM3308H/UM3308UK/UM3308QA (block diagram see Figure 1) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a dc state, the output drivers of the UM3308/UM3308H/UM3308UK/UM3308QA can maintain a high or low, but are designed to be weak, so that they can be overdriven by an external driver when data on the bus starts flowing to the opposite direction.

The output one shot detects rising or falling edges on the A or B ports. During a rising edge, the one shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition.

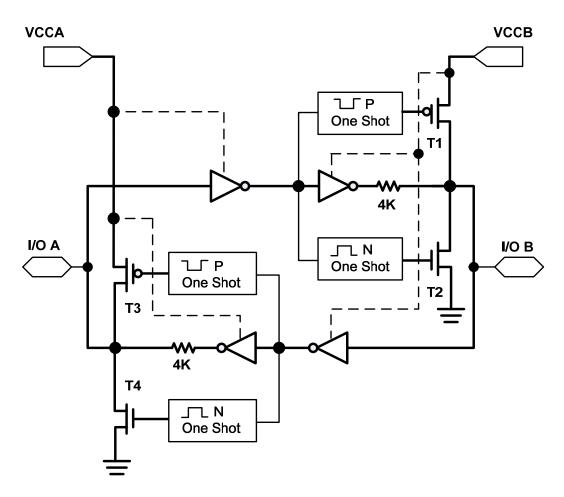
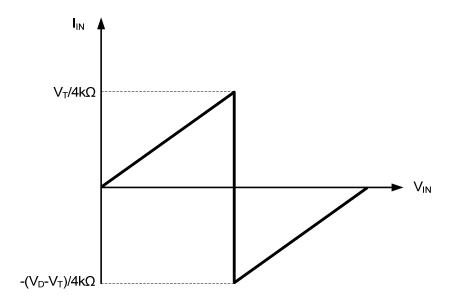


Figure 1 Block Diagram of UM3308/UM3308H/UM3308UK/UM3308QA I/O Cell



Input Driver Requirements

Typical I_{IN} vs V_{IN} characteristics of the UM3308/UM3308H/UM3308UK/UM3308QA are shown in Figure 2. For proper operation, the device driving the data I/Os of the UM3308/UM3308H/UM3308UK/UM3308QA must have drive strength of at least $\pm 2mA$.



A: V_T is the input threshold voltage of the UM3308/UM3308H/UM3308UK/UM3308QA (typical $V_{\rm CCI}/2$).

B: V_D is the supply voltage of the external driver.

Figure 2 Typical I_{IN} vs. V_{IN} Curve

Power Up

During operation, ensure that $V_{CCA} \le V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} \ge V_{CCB}$ does not damage the device, so any power supply can be ramped up first. The UM3308/UM3308H/UM3308UK/UM3308QA has circuitry that disables all output ports when either V_{CC} is switched off ($V_{CCA/B} = 0$ V).

Enable and Disable

The UM3308/UM3308H/UM3308UK/UM3308QA has an OE input that is used to disable the device by setting OE=low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t_{dis}) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

Pull-up or Pull-down Resistors on I/O Lines

The UM3308/UM3308H/UM3308UK/UM3308QA is designed to drive capacitive loads of up to 50pF. The output drivers of the UM3308/UM3308H/UM3308UK/UM3308QA have low dc drive strength. If pull-up or pull-down resistors are connected externally to the data I/Os, their values must be kept higher than 50k Ω to ensure that they do not contend with the output drivers of theUM3308/UM3308H/UM3308UK/UM3308QA.



For the same reason, the UM3308/UM3308H should not be used in applications such as I^2C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O.



Typical Operating Circuit

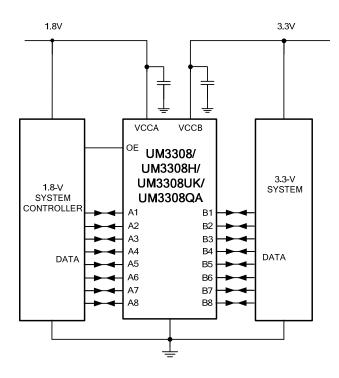
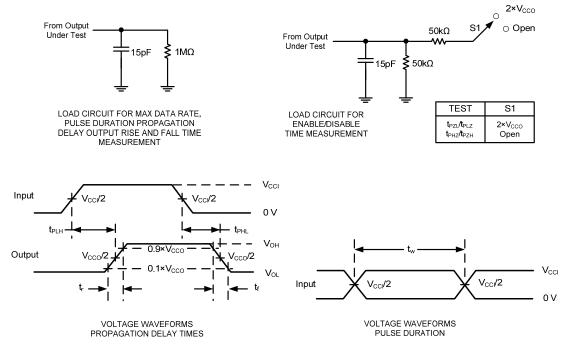


Figure 3 Typical Operating Circuit

Test Circuits



- A. C_L includes probe and jig capacitance. B. All input pulses are supplied by generators having the following characteristics: $PRR \le 10MHz$, $Z_C = 50\Omega$, $dv/dt \ge 1v/ns$. C. The outputs are measured one at a time, with one transition per measurement. D. t_{PLH} and t_{PHL} are the same as t_{pol} . E. V_{CC} is the V_{CC} associated with the input port.

- F. $V_{\rm CCO}$ is the $V_{\rm CC}$ associated with the output port. G. All parameters and waveforms are not applicable to all devices.

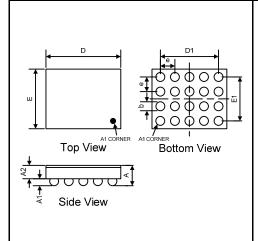
Figure 4 Load Circuits and Voltage Waveforms



Package Information

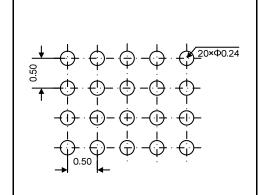
UM3308/UM3308H: CSP20 2.4×1.9

Outline Drawing



	DIMENSIONS										
Cb al	MIL	LIMET	ERS	INCHES							
Symbol	Min	Тур	Max	Min	Тур	Max					
A	-	-	0.68	-	-	0.027					
A1	0.21	0.231	0.24	0.0083	0.0091	0.0094					
A2	0.40	0.42	0.44	0.0157	0.0165	0.0173					
b	0.27	0.30	0.32	0.011	0.012	0.013					
D	2.32	2.35	2.40	0.091	0.093	0.094					
D1		2.00BSC	7	(0.079BSC	2					
Е	1.82	1.85	1.90	0.072	0.073	0.075					
E1		1.50BSC	7	0.059BSC							
e		0.50BSC	7	(0.020BSC						

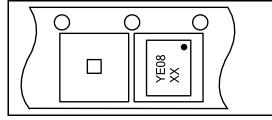
Land Pattern



NOTES:

- 1. Bump is Lead Free Sn/Ag/Cu.
- 2. Unit: mm.
- 3. Non-solder mask defined copper landing pad.
- 4. Laser Mark on silicon die back; back-lapped.

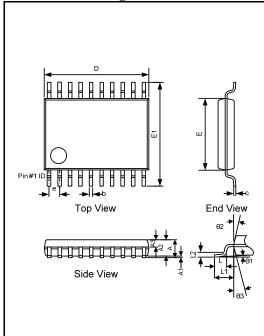
Tape and Reel Orientation





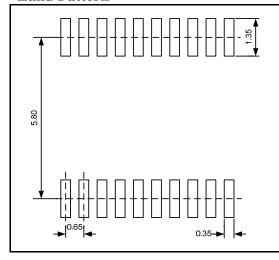
UM3308UK TSSOP20

Outline Drawing



DIMENSIONS									
Symbol	MILLIMETERS			INCHES					
	Min	Тур	Max	Min	Тур	Max			
A	-	-	1.20	-	-	0.047			
A1	0.05	1	0.15	0.002	-	0.006			
A2	0.80	1	1.05	0.031	-	0.041			
A3	0.34	0.44	0.54	0.013	0.017	0.021			
b	0.19	1	0.30	0.007	-	0.012			
c	0.09	-	0.20	0.004	-	0.008			
D	6.40	6.50	6.60	0.252	0.256	0.260			
Е	4.30	4.40	4.50	0.169	0.173	0.177			
E1	6.20	6.40	6.60	0.244	0.252	0.260			
e	0.65BSC			0.026BSC					
L	0.45	0.60	0.75	0.018	0.024	0.030			
L1	1.00REF			0.039REF					
L2	0.25BSC			0.010BSC					
θ1	0°	-	8°	0°	-	8°			
θ2	10°	12°	14°	10°	12°	14°			
θ3	10°	12°	14°	10°	12°	14°			

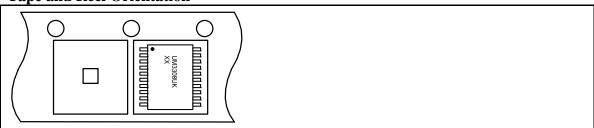
Land Pattern



NOTES:

- 1. Compound dimension: 6.50×4.40.
- 2. Unit: mm.
- 3. General tolerance ±0.05mm unless otherwise specified.
- 4. The layout is just for reference.

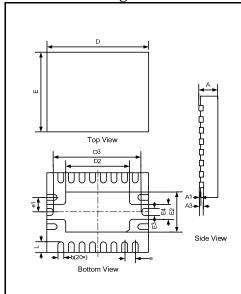
Tape and Reel Orientation





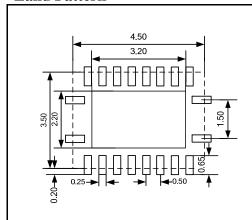
UM3308QA QFN20 4.5×3.5

Outline Drawing



DIMENSIONS									
Symbol	MILLIMETERS			INCHES					
	Min	Тур	Max	Min	Тур	Max			
A	0.70	0.75	0.80	0.028	0.030	0.032			
A1	ı	0.01	0.05	-	0.0004	0.002			
A3	0.18	0.20	0.25	0.007	0.008	0.010			
b	0.18	0.25	0.30	0.007	0.010	0.012			
D	4.40	4.50	4.60	0.176	0.180	0.184			
D2	3.10	3.20	3.30	0.124	0.128	0.132			
D3	3.85REF			0.154REF					
Е	3.40	3.50	3.60	0.136	0.140	0.144			
E2	2.10	2.20	2.30	0.084	0.088	0.092			
E3	0.35REF			0.014REF					
E4	0.75REF			0.030REF					
e	0.50BSC			0.020BSC					
e1	0.75BSC			0.030BSC					
L	0.35	0.40	0.45	0.014	0.016	0.018			

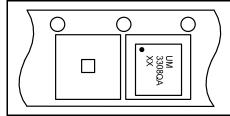
Land Pattern



NOTES:

- 1. Compound dimension: 4.50×3.50;
- 2. Unit: mm;
- 3.General tolerance ± 0.05 mm unless otherwise specified;
- 4. The layout is just for reference.

Tape and Reel Orientation





GREEN COMPLIANCE

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http://www.union-ic.com/index.aspx?cat code=RoHSDeclaration

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